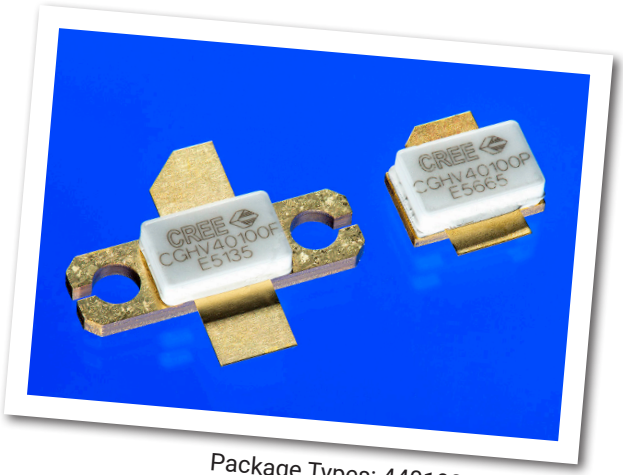
CGHV40100

100 W, DC - 3.0 GHz, 50 V, GaN HEMT

Cree's CGHV40100 is an unmatched, gallium nitride (GaN) high electron mobility transistor (HEMT). The CGHV40100, operating from a 50 volt rail, offers a general purpose, broadband solution to a variety of RF and microwave applications. GaN HEMTs offer high efficiency, high gain and wide bandwidth capabilities making the CGHV40100 ideal for linear and compressed amplifier circuits. The transistor is available in a 2-lead flange and pill package.



Package Types: 440193 & 440206
PN: CGHV40100F & CGHV40100P

Typical Performance Over 500 MHz - 2.5 GHz (T_c = 25°C), 50 V

Parameter	500 MHz	1.0 GHz	1.5 GHz	2.0 GHz	2.5 GHz	Units
Small Signal Gain	17.6	16.9	17.7	17.5	14.8	dB
Saturated Output Power	147	100	141	116	112	W
Drain Efficiency @ P_{SAT}	68	56	58	54	54	%
Input Return Loss	6	5.1	10.5	5.5	8.8	dB

Note:
Measured CW in the CGHV40100F-AMP application circuit.

Features

RoHS COMPLIANT

- Up to 3 GHz Operation
- 100 W Typical Output Power
- 17.5 dB Small Signal Gain at 2.0 GHz
- Application Circuit for 0.5 - 2.5 GHz
- 55% Efficiency at P_{SAT}
- 50 V Operation

Large Signal Models Available for ADS & MWO

Rev 3.5 - March 2020

Absolute Maximum Ratings (not simultaneous) at 25˚C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V_{DSS}	150	Volts	25˚C
Gate-to-Source Voltage	V_{GS}	-10, +2	Volts	25˚C
Storage Temperature	T_{STG}	-65, +150	˚C	
Operating Junction Temperature	T_J	225	˚C	
Maximum Forward Gate Current	I_{GMAX}	20.8	mA	25˚C
Maximum Drain Current[1]	I_{DMAX}	8.7	A	25˚C
Soldering Temperature[2]	T_S	245	˚C	
Screw Torque	τ	40	in-oz	
Thermal Resistance, Junction to Case[3]	$R_{\theta JC}$	1.62	˚C/W	85˚C
Thermal Resistance, Junction to Case[4]	$R_{\theta JC}$	1.72	˚C/W	85˚C
Case Operating Temperature[5]	T_C	-40, +150	˚C	

Note:
[1] Current limit for long term, reliable operation
[2] Refer to the Application Note on soldering at www.cree.com/RF/Document-Library
[3] Measured for the CGHV40100P at P_{DISS} = 83 W.
[4] Measured for the CGHV40100F at P_{DISS} = 83 W.
[5] See also, Power Derating Curve on Page 5.

Electrical Characteristics (T_C = 25˚C)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics[1]						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	V_{DC}	V_{DS} = 10 V, I_D = 20.8 mA
Gate Quiescent Voltage	$V_{GS(Q)}$	–	-2.7	–	V_{DC}	V_{DS} = 50 V, I_D = 0.6 A
Saturated Drain Current[2]	I_{DS}	13.5	19.3	–	A	V_{DS} = 6.0 V, V_{GS} = 2.0 V
Drain-Source Breakdown Voltage	V_{BR}	125	–	–	V_{DC}	V_{GS} = -8 V, I_D = 20.8 mA
RF Characteristics[3] (T_C = 25˚C, F_0 = 2.0 GHz unless otherwise noted)						
Small Signal Gain	G_{SS}	16	17.5	–	dB	V_{DD} = 50 V, I_{DQ} = 0.6 A
Power Gain	G_P	–	11.0	–	dB	V_{DD} = 50 V, I_{DQ} = 0.6 A, P_{OUT} = P_{SAT}
Output Power at Saturation[4]	P_{SAT}	50	116	–	W	V_{DD} = 50 V, I_{DQ} = 0.6 A
Drain Efficiency	η	47	54	–	%	V_{DD} = 50 V, I_{DQ} = 0.6 A, P_{OUT} = P_{SAT}
Output Mismatch Stress	VSWR	–	–	10 : 1	Ψ	No damage at all phase angles, V_{DD} = 50 V, I_{DQ} = 0.6 A, P_{OUT} = 100 W CW
Dynamic Characteristics[5]						
Input Capacitance	C_{GS}	–	29.3	–	pF	V_{DS} = 50 V, V_{gs} = -8 V, f = 1 MHz
Output Capacitance	C_{DS}	–	7.3	–	pF	V_{DS} = 50 V, V_{gs} = -8 V, f = 1 MHz
Feedback Capacitance	C_{GD}	–	0.61	–	pF	V_{DS} = 50 V, V_{gs} = -8 V, f = 1 MHz

Notes:
[1] Measured on wafer prior to packaging.
[2] Scaled from PCM data.
[3] Measured in CGHV40100-AMP
[4] P_{SAT} is defined as I_G = 0.208 mA.
[5] Includes package

Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

Figure 1. - Small Signal Gain and Return Losses versus Frequency measured in application circuit CGHV40100-AMP
V_{DD} = 50 V, I_{DQ} = 600 mA, Tcase = 25°C

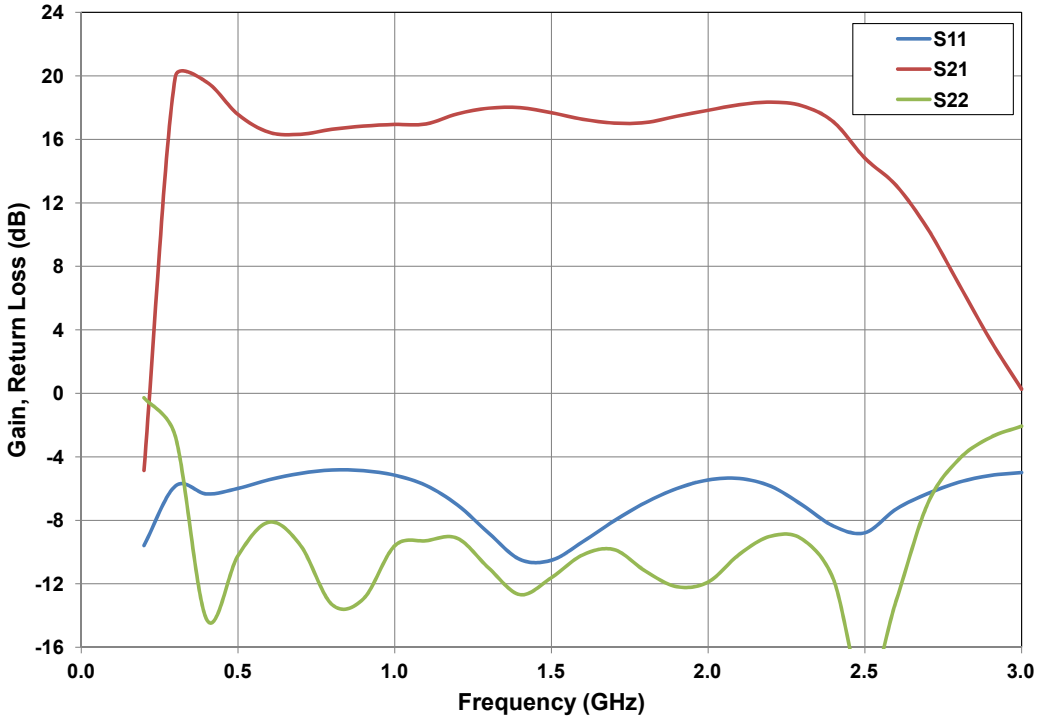
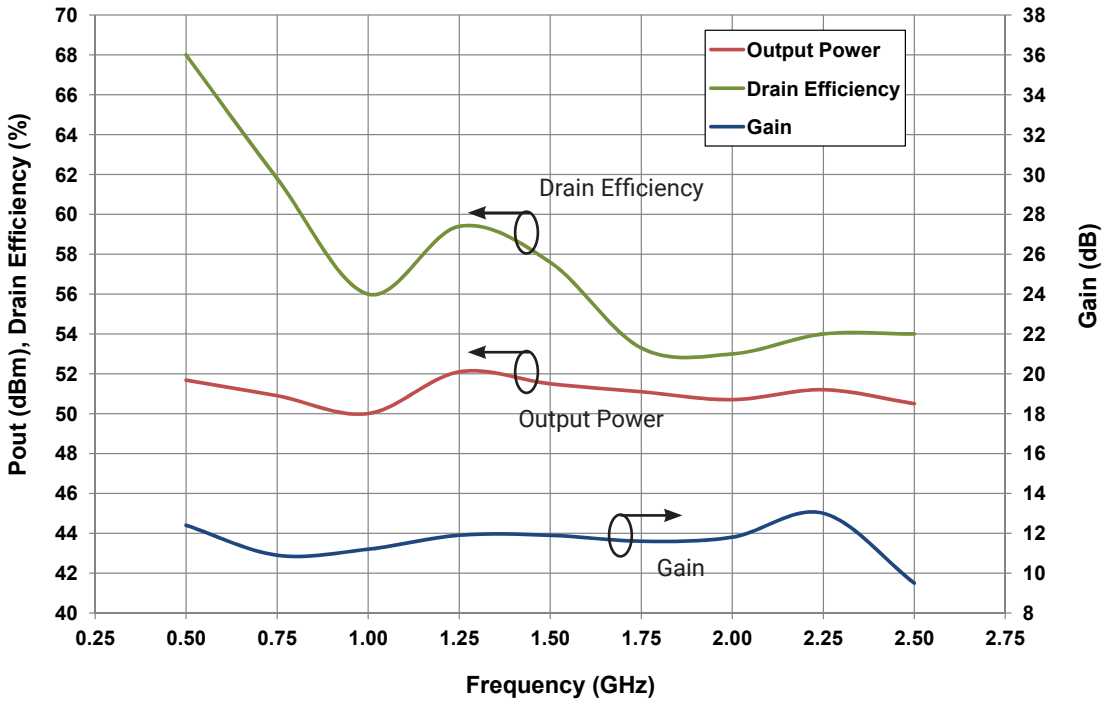


Figure 2. - Output Power and Drain Efficiency vs Frequency
V_{DD} = 50 V, I_{DQ} = 600 mA



Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

Figure 3. - Third Order Intermodulation Distortion vs Average Output Power measured in Broadband Amplifier Circuit CGHV40100-AMP Spacing = 1 MHz, V_{DD} = 50 V, I_{DQ} = 600 mA, Tcase = 25°C

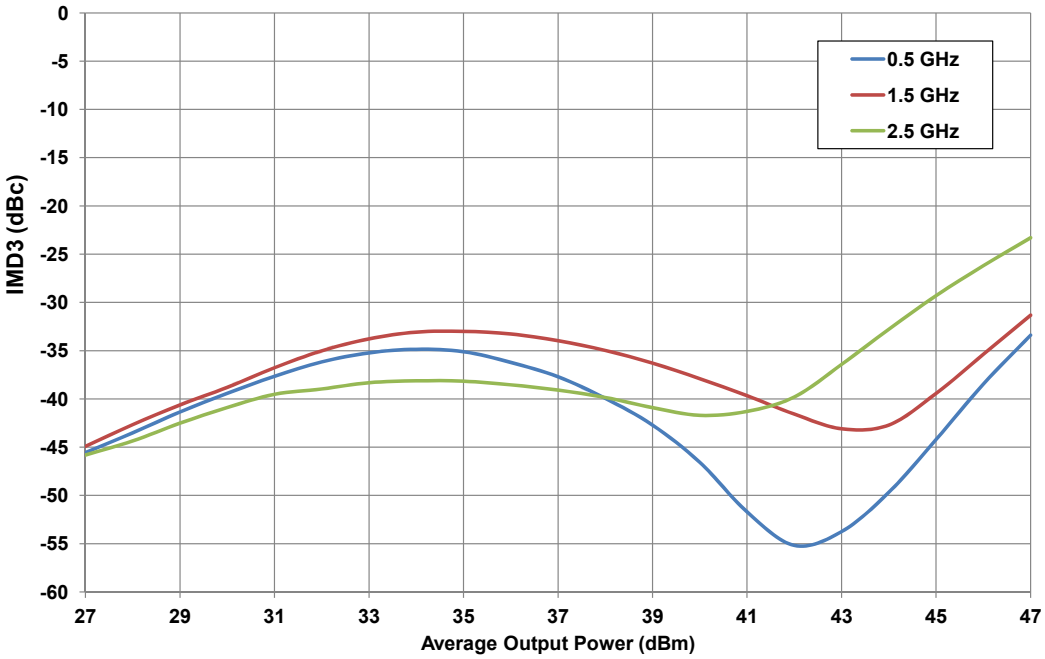
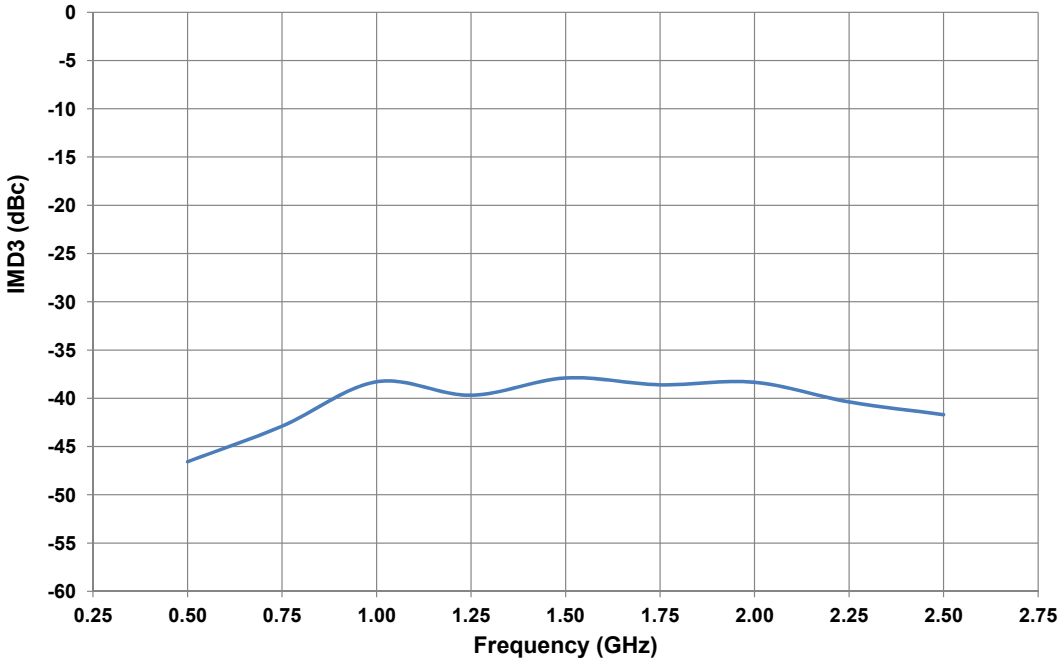


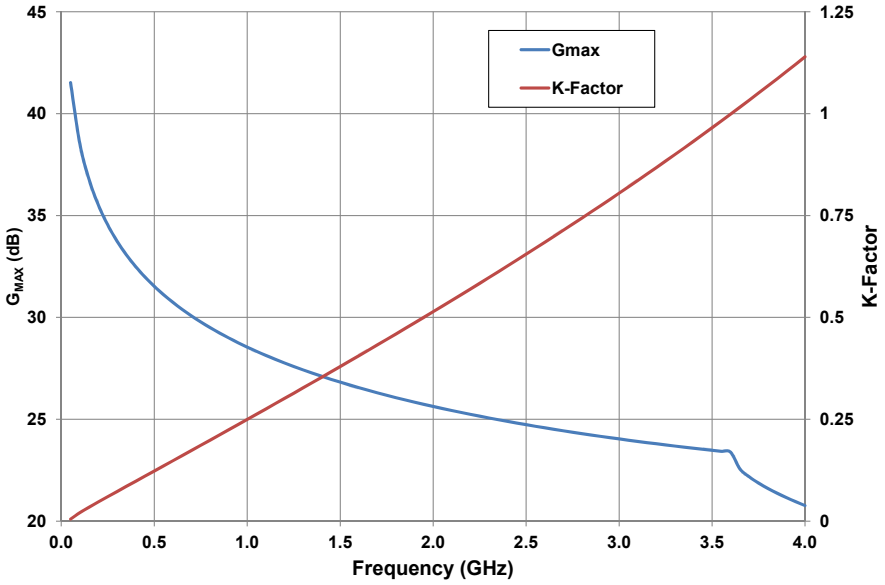
Figure 4. - Third Order Intermodulation Distortion vs Frequency measured in Broadband Amplifier Circuit CGHV40100-AMP Spacing = 1 MHz, V_{DD} = 50 V, I_{DQ} = 600 mA, Tcase = 25°C



Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

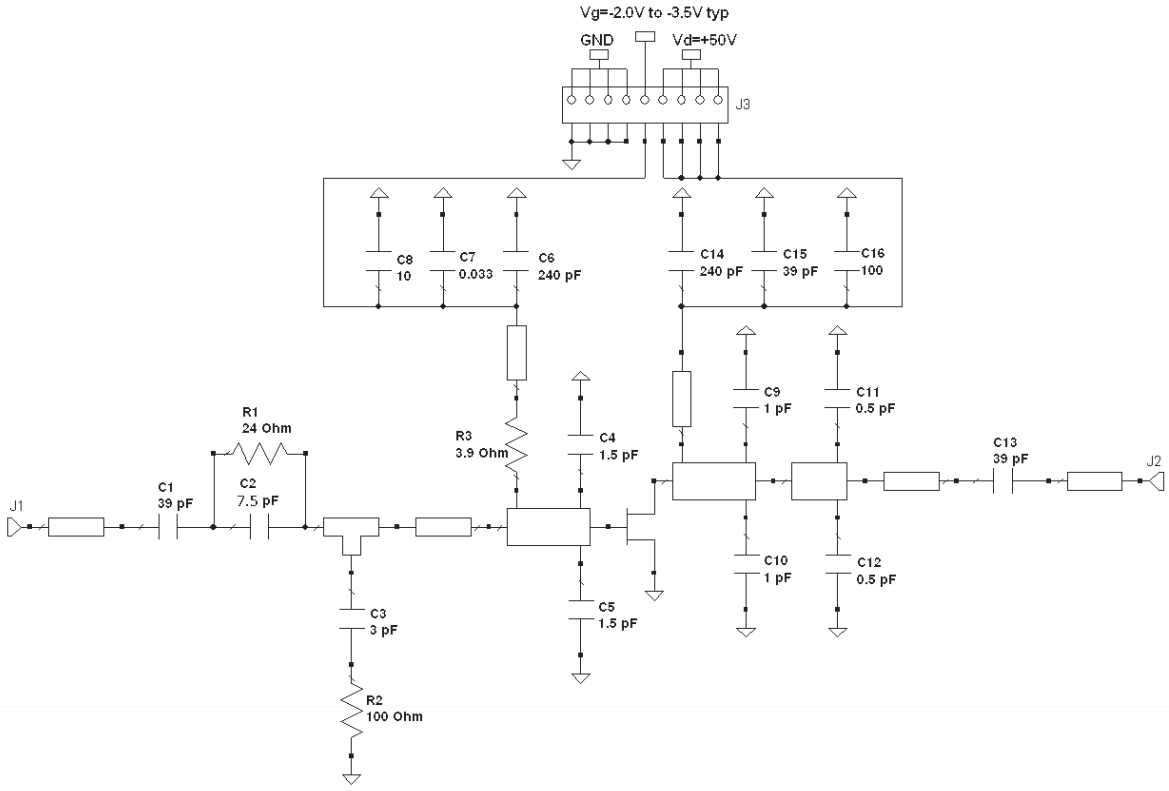
Figure 5. - G_{MAX} and K-Factor vs Frequency
V_{DD} = 50 V, I_{DQ} = 600 mA, Tcase = 25°C



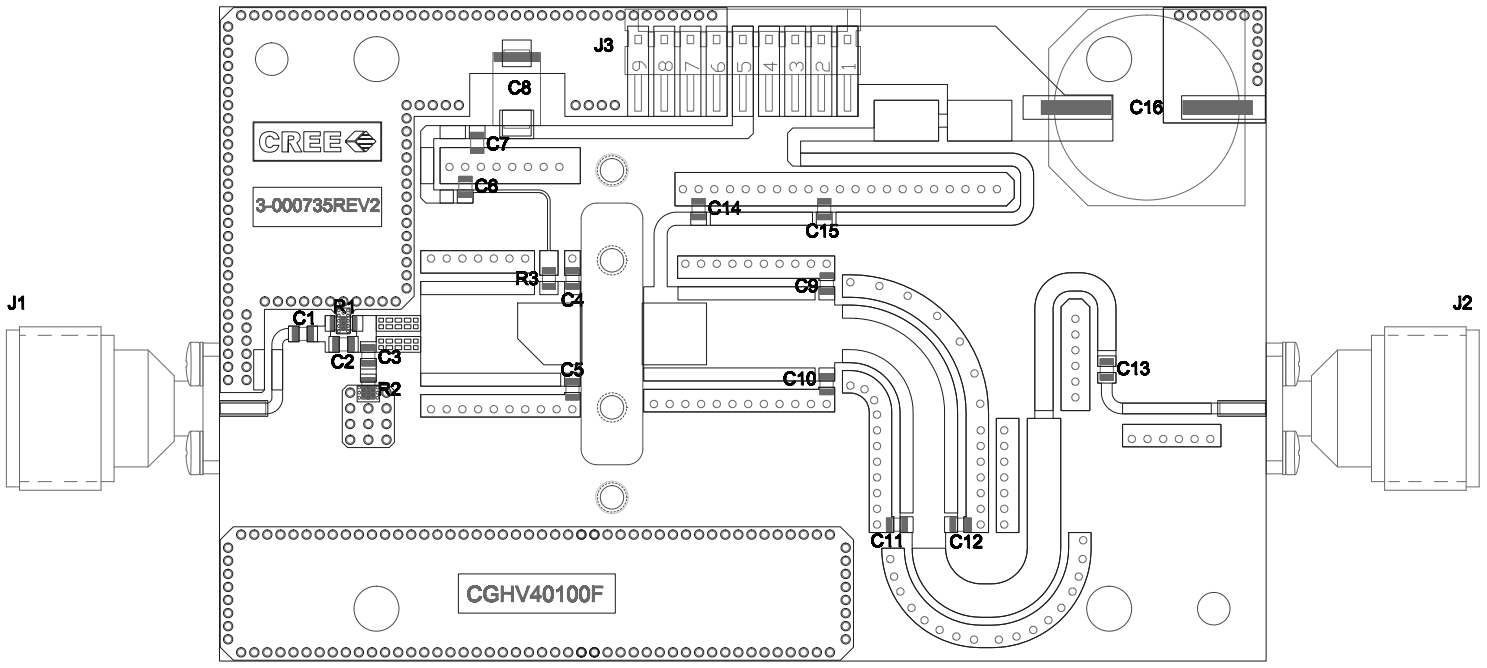
Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

CGHV40100-AMP Application Circuit Schematic



CGHV40100-AMP Application Circuit



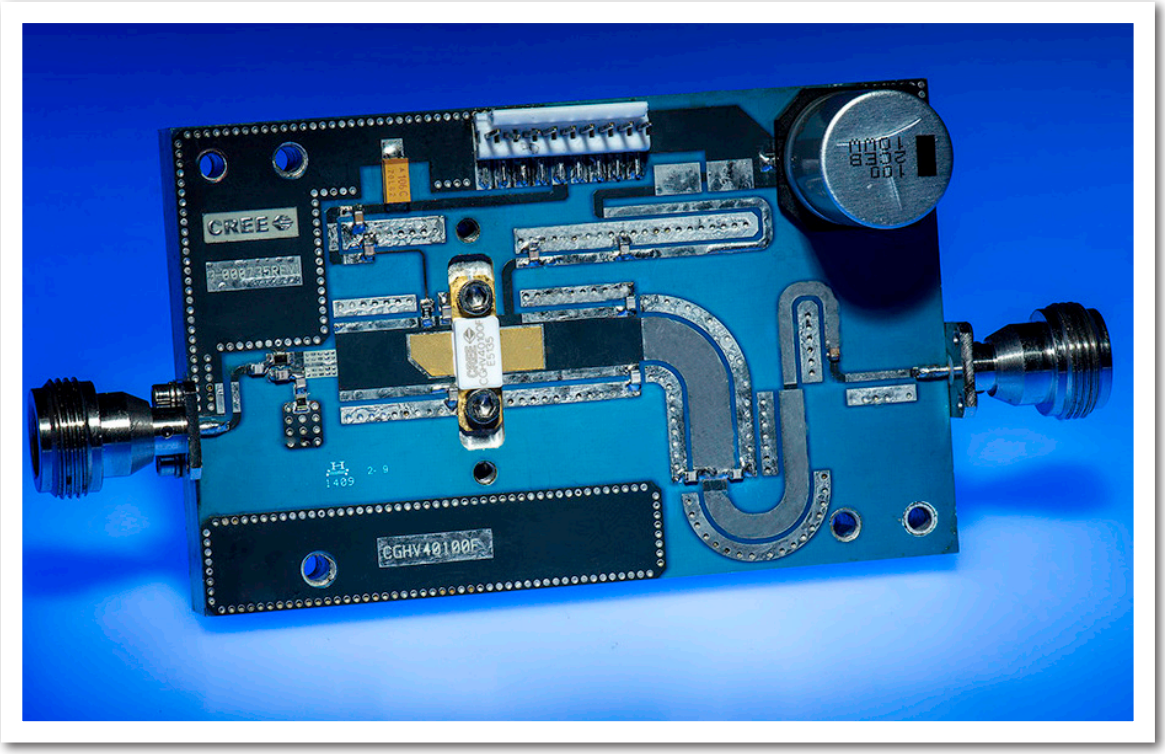
Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

CGHV40100-AMP Application Circuit Bill of Materials

Designator	Description	Qty
C1, C13, C15	CAP, 39 pF, ± 0.1 pF, 250V, 0805, ATC600F	3
C2	CAP, 7.5 pF, ± 0.1 pF, 250 V, 0806, ATC600F	1
C3	CAP, 3 pF ± 0.1 pF, 250 V, 0805, ATC600F	1
C4, C5	CAP, 1.5 pF, ± 0.1 pF, 250 V, 0805, ATC600F	2
C7	CAP, 33000 pF, 0805 100V, X7R	1
C6, C14	CAP, 240 pF, ± 0.5 pF, 250 V, 0805, ATC600F	2
C8	CAP, 10 UF, 16V TANTALUM, 2312	1
C9, C10	CAP, 1 pF, ± 0.1 pF, 250 V, 0805, ATC600F	2
C11, C12	CAP, 0.5 pF, ± 0.1 pF, 250 V, 0805, ATC600F	2
C16	CAP, 100 UF, 20%, 160 V, ELEC	1
R1	RES, 24 OHMS, IMS ND3-1005CS24R0G	1
R2	RED, 100 OHMS, IMS ND3-0805EW1000G	1
R3	RES, 3.9 OHMS, 0805	1
J1, J2	CONN, SMA, PANEL MOUNT JACK	2
J3	HEADER RT>PLZ .1CEN LK 9POS	1
	BASEPLATE, CGH35120	1
	PCB, RO4350B, 2.5” X 4” X 0.020”, CGHV40100F	1

CGHV40100-AMP Demonstration Amplifier Circuit



Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

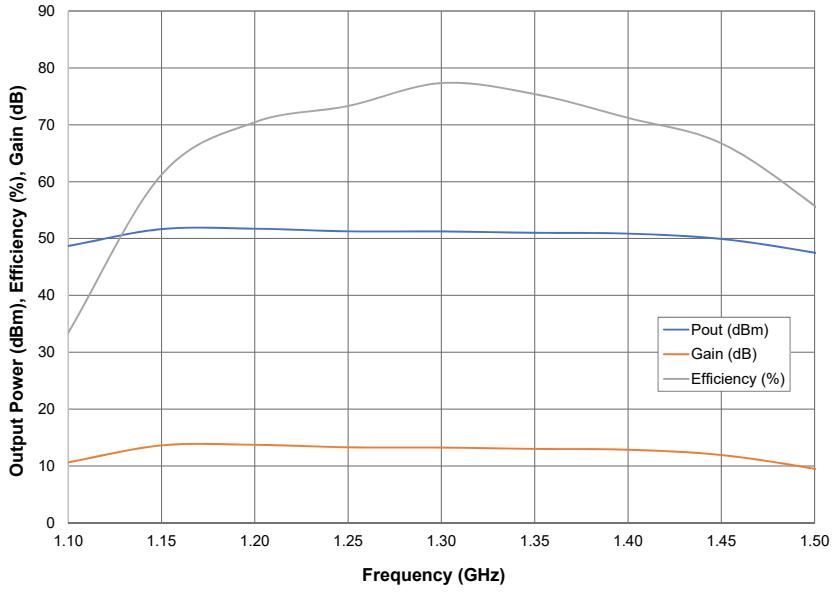
Electrical Characteristics When Tested in CGHV40100F-AMP2

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
RF Characteristics[1] (T_C = 25°C, F_0 = 1.2 - 1.4 GHz unless otherwise noted)						
Output Power	P_{OUT}	–	51	–	dBm	V_{DD} = 50 V, I_{DQ} = 10 mA, P_{IN} = 38 dBm
Drain Efficiency	η	–	72	–	%	V_{DD} = 50 V, I_{DQ} = 10 mA, P_{IN} = 38 dBm
Output Mismatch Stress	VSWR	–	10 : 1	–	Ψ	No damage at all phase angles, V_{DD} = 50 V, I_{DQ} = 10 mA, P_{IN} = 38 dBm

Notes:
Measured in CGHV40100F-AMP2 Application Circuit

Typical Performance in Application Circuit CGHV40100F-AMP2

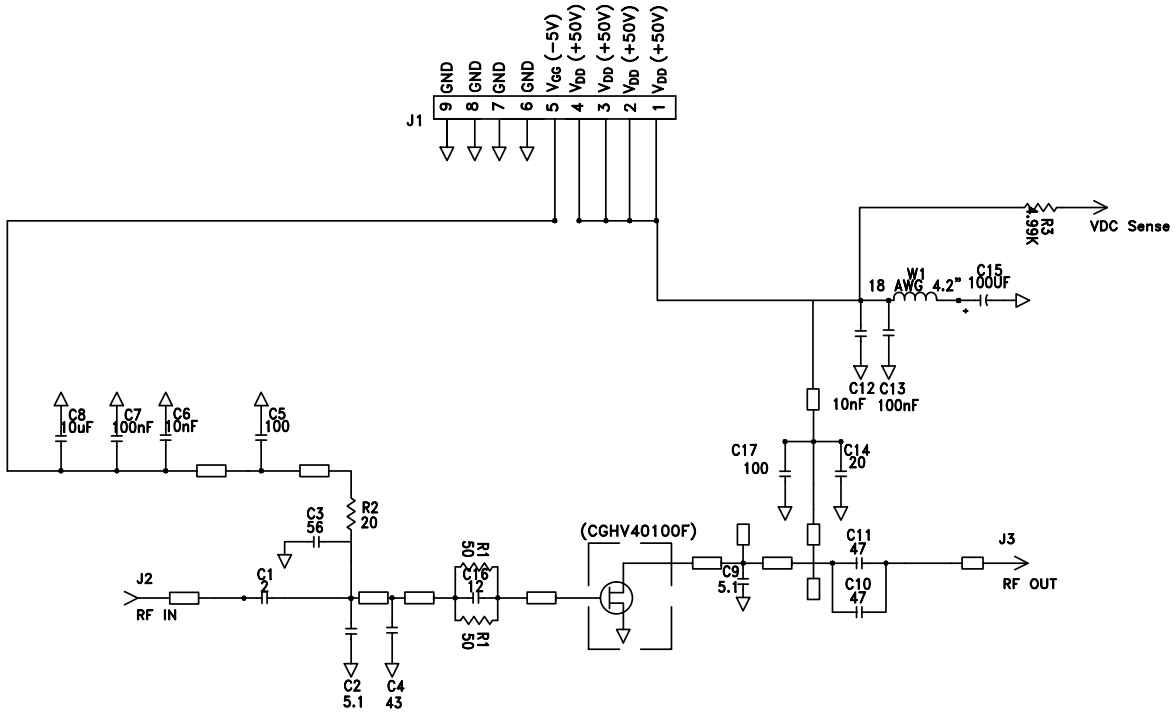
Figure 6. - Output Power, Efficiency, and Gain vs. Frequency of the CGHV40100F Measured in Demonstration Amplifier Circuit CGHV40100F-AMP2 V_{DD} = 50 V, I_{DQ} = 10 mA, Pulse Width = 100 µS, Duty Cycle = 10%



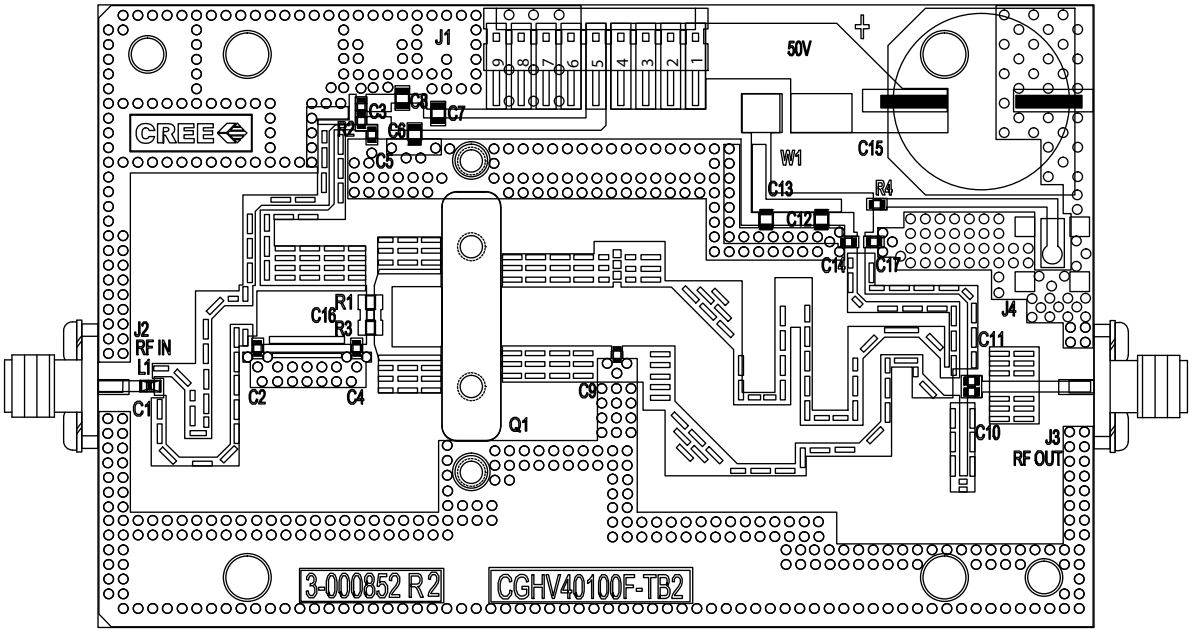
Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

CGHV40100F-AMP2 Demonstration Amplifier Circuit Schematic



CGHV40100F-AMP2 Demonstration Amplifier Circuit Outline



Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

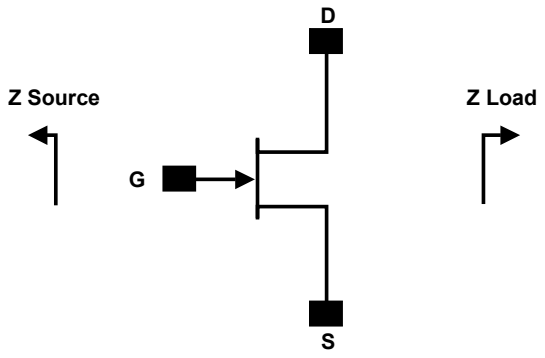
CGHV40100F-AMP2 Bill of Materials

Designator	Description	Qty
C1	CAP, 2.0pF, +/-0.1pF, 0603, ATC	1
R2	RES, 1/16W, 0603, 1%, 20 Ohms	1
R4	RES,1/16W,0603,1%,4.99K OHMS	1
R1, R3	RES, AIN, 50.0 OHM, +/- 5%, 0505, PtAg TERMINATION	1
C8	CAP, 10UF, 10%, 1206, 16V	1
C1, C5, C17	CAP, 100.0pF, +/-5%, 0603, ATC	3
C16	CAP, 12.0pF, +/-5%, 0603, ATC600	1
C14	CAP, 20.0pF, +/-5%, 0603, ATC600S	1
C4	CAP, 43pF,+/-5%pF, 0603, ATC	1
C10, C11	CAP, 47pF,+/-5%pF, 0603, ATC	2
C3	CAP, 56PF +/- 5%, 0603 , ATC600S	1
C2, C9	CAP, 5.1PF, +/-0.05 PF, 0603, 600S	2
C6, C12	CAP,0805,100V,TEMP STBL,1000PF	2
C7, C13	CAP, 10000PF, +/-10%, 0805, X7R, 100V, TEMP STBL	2
	PCB, RO4350, 0.020 THK, CGHV40100F-TB2 1.2-1.4GHz RADAR	1
	BASEPLATE, AL, 4.00 X 2.50 X 0.49 FOR THRU HOLE CAPACITORS	1
	2-56 SOC HD SCREW 1/4 SS	4
	#2 SPLIT LOCKWASHER SS	4
J2, J3	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST	2
J4	CONN, SMB, STRAIGHT JACK RECEPTACLE, SMT, 50 OHM, Au PLATED	1
J1	HEADER RT>PLZ .1CEN LK 9POS	1
W1	WIRE, BLACK, 18 AWG, EXTRUDED TFE TEFLON	1
L1	INDUCTOR,CHIP,2.2nH,0603 SMT	1
C2	CAP, 6.8pF, +/- 0.25 pF, 0603, ATC	1
C15	CAP, 100uF, +/-20%, 100V, ALUM ELEC	1
Q1	Transistor CGHV40100F	1

Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

Source and Load Impedances



Frequency (MHz)	Z Source	Z Load
500	0.43 + j5.25	8.83 + j0.85
750	0.40 + j2.62	10.78 + j2.50
1000	0.30 + j1.31	9.06 + 4.23
1250	0.30 + j0.44	7.40 + j3.85
1500	0.30 - j0.44	6.39 + j3.44
1750	0.25 - j0.87	4.41 + j3.03
2000	0.25 - j1.31	3.68 + j2.17
2250	0.25 - j2.18	3.42 + j2.17
2500	0.26 - j2.62	2.65 + j1.74

Note 1. V_{DD} = 50 V, I_{DQ} = 600 mA in the 440193 package.
Note 2. Optimized for power gain, P_{SAT} and PAE.

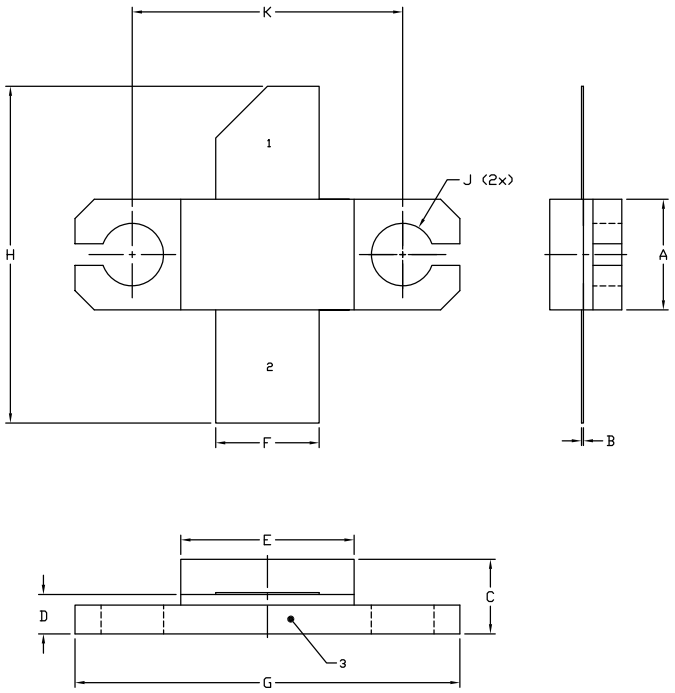
Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	2 (125 V to 250 V)	JEDEC JESD22 C101-C

Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

Product Dimensions CGHV40100F (Package Type — 440193)



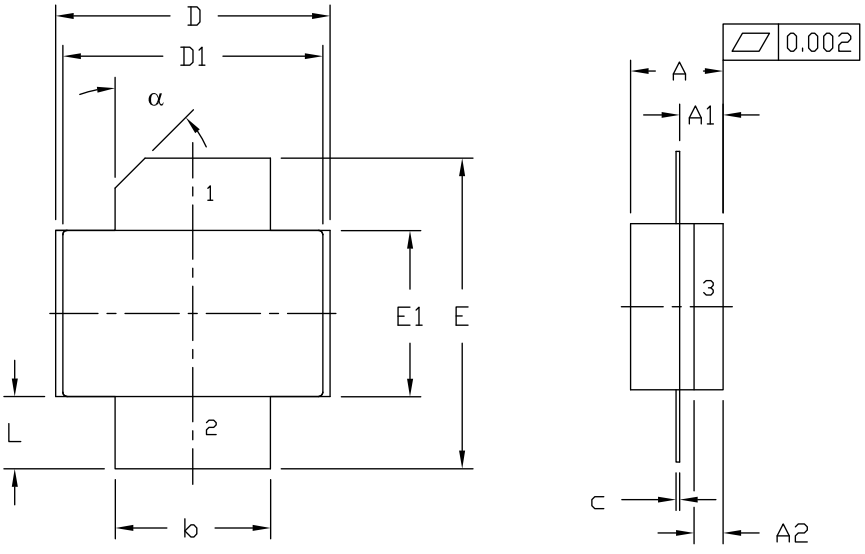
NOTES:

1. DIMENSIONING AND TOLERANICING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE NI/AU

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.225	0.235	5.72	5.97
B	0.004	0.006	0.10	0.15
C	0.145	0.165	3.68	4.19
D	0.077	0.087	1.96	2.21
E	0.355	0.365	9.02	9.27
F	0.210	0.220	5.33	5.59
G	0.795	0.805	20.19	20.45
H	0.670	0.730	17.02	18.54
J	ø .130		3.30	
k	0.562		14.28	

PIN 1. GATE
PIN 2. DRAIN
PIN 3. SOURCE

Product Dimensions CGHV40100P (Package Type — 440206)



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M – 1994.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

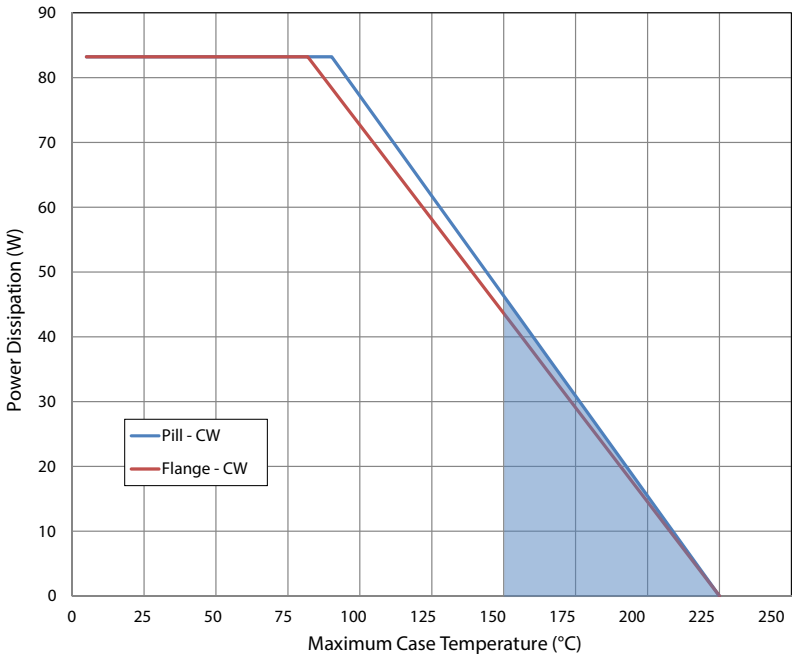
DIM	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.125	0.145	3.18	3.68	
A1	0.057	0.067	1.45	1.70	
A2	0.035	0.045	0.89	1.14	
b	0.210	0.220	5.33	5.59	2x
c	0.004	0.006	0.10	0.15	2x
D	0.375	0.385	9.53	9.78	
D1	0.355	0.365	9.02	9.27	
E	0.400	0.460	10.16	11.68	
E1	0.225	0.235	5.72	5.97	
L	0.085	0.115	2.16	2.92	2x
α	45° REF		45° REF		

PIN 1. GATE
2. DRAIN
3. SOURCE

Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

Figure 7. - Transient Power Dissipation De-Rating Curve

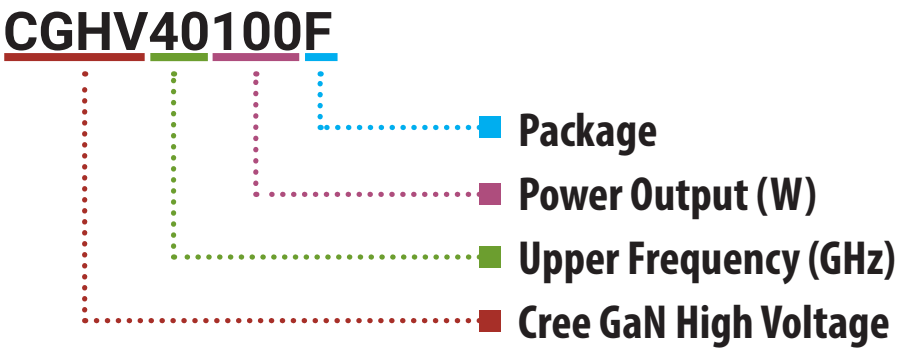


Note 1. Area exceeds Maximum Case Temperature (See Page 2).

Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

Part Number System



Parameter	Value	Units
Upper Frequency[1]	4.0	GHz
Power Output	100	W
Package	Flange	-

Table 1.

Note[1]: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

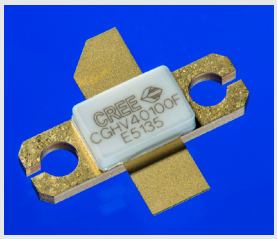
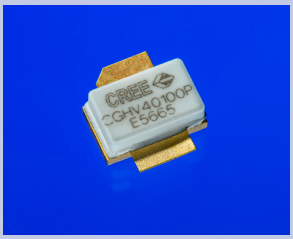
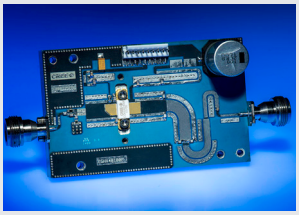
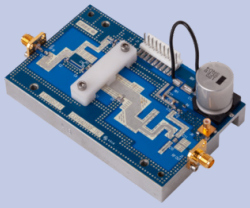
Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.

Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGHV40100F	GaN HEMT	Each	
CGHV40100P	GaN HEMT	Each	
CGHV40100F-AMP	Test board with GaN HEMT (CGHV40100F) installed, operating from 0.5 - 2.5 GHz for communications or ISM applications.	Each	
CGHV40100F-AMP2	Test board with GaN HEMT (CGHV40100F) installed, operating from 1.2 - 1.4 GHz for L-Band Radar.	Each	

Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf

Disclaimer

Specifications are subject to change without notice. Cree, Inc. believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Cree for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Cree. Cree makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. “Typical” parameters are the average values expected by Cree in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer’s technical experts for each application. Cree products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Cree product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility.

For more information, please contact:

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
rfsales@cree.com
www.cree.com/RF

Copyright © 2014-2020 Cree, Inc. All rights reserved. The information in this document is subject to change without notice. Cree and the Cree logo are registered trademarks of Cree, Inc.

Cree, Inc.
4600 Silicon Drive
Durham, North Carolina, USA 27703
USA Tel: +1.919.313.5300
Fax: +1.919.869.CREE
rfsales@cree.com
www.cree.com/rf